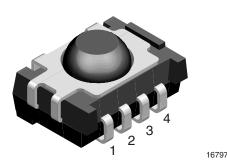


www.vishay.com

Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



FEATURES

- · Improved dark sensitivity
- · Improved immunity against optical noise
- Very low supply current
- · Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.0 V to 3.6 V
- Insensitive to supply voltage ripple and noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

LINKS TO ADDITIONAL RESOURCES









DESCRIPTION

The TSOP96... series devices are the latest generation miniaturized IR receiver modules for infrared remote control systems. These series provide improvements in sensitivity to remote control signals in dark ambient as well as in sensitivity in the presence of optical disturbances e.g. from CFLs.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding.

The TSOP966.. series devices are designed to receive long burst codes (10 or more carrier cycles per burst). The third digit designates the AGC level (AGC6) and the last two digits designate the band-pass frequency (see table below). The higher the AGC, the better noise is suppressed, but the lower the code compatibility. AGC6 provides maximized noise suppression. Generally, we advise to select the highest AGC that satisfactorily receives the desired remote code.

These components have not been qualified to automotive specifications.

MECHANICAL DATA

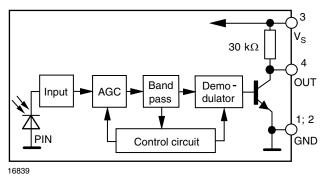
 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$

ORDERING CODE

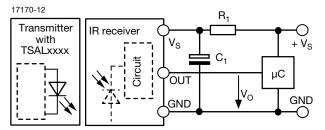
Taping:

TSOP96...TT - top view taped, 1190 pcs/reel TSOP96...TR - side view taped, 1120 pcs/reel

BLOCK DIAGRAM



APPLICATION CIRCUIT



 $\rm R_{1}$ and $\rm C_{1}$ recommended to reduce supply ripple for $\rm V_{S} < 2.2~V$



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PARTS TA	BLE			
AGC		MAXIMIZED NOISE SUPPRESSION (AGC6)		
	30 kHz	TSOP96630		
	33 kHz	TSOP96633		
Carrier	36 kHz	TSOP96636 (5)(6)		
frequency	38 kHz	TSOP96638 (3)(4)(11)		
	40 kHz	TSOP96640		
	56 kHz	TSOP96656		
Package		Panhead		
Pinning		1 = GND, 2 = N.C., 3 = V _S , 4 = OUT		
Dimensions (mm)	7.5 W x 5.3 H x 4.0 D		
Mounting		SMD		
Application		Remote control		
Best choice for		(1) Cisco (2) MCIR (3) Mitsubishi (4) NEC (5) Panasonic (6) RC-5 (7) RC-6 (8) RCA (9) r-step (10) Sejin 4PPM (11) Sharp (12) Sony		
Special optio	ns	 Narrow optical filter: www.vishay.com/doc?81590 Wide optical filter: www.vishay.com/doc?82726 		

Notes

- 30 kHz and 33 kHz only available on written request
- See datasheet for TSOP962.., TSOP964.. for preferred devices for (1)(2)(7)(8)(9)(10)(12)

ABSOLUTE MAXIMUM R	ATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +3.6	V
Supply current		I _S	3	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		l _O	5	mA
Junction temperature		T _j	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTI	CAL CHARACTERISTICS	(T _{amb} = 25 °C	C, unless o	therwise sp	ecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current	$E_{V} = 0, V_{S} = 3.3 V$	I _{SD}	0.25	0.37	0.45	mA
Supply current	$E_v = 40$ klx, sunlight	I _{SH}	-	0.50	-	mA
Supply voltage		Vs	2.0	-	3.6	V
Transmission distance	$E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, $I_F = 50$ mA	d	-	26	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Test signal: NEC code	E _{e min.}	-	0.1	0.2	mW/m ²
Maximum irradiance	t_{pi} - 5/f ₀ < t_{po} < t_{pi} + 6/f ₀ , test signal see Fig. 1	E _{e max.}	30	-	-	W/m ²
Directivity	Angle of half transmission distance	Ψ1/2	-	± 50	-	0

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

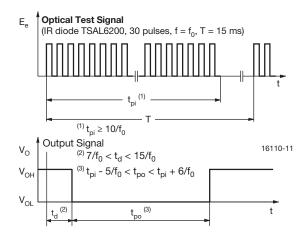


Fig. 1 - Output Delay and Pulse-Width

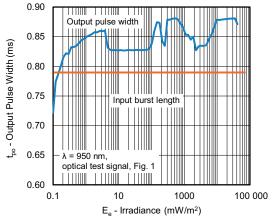
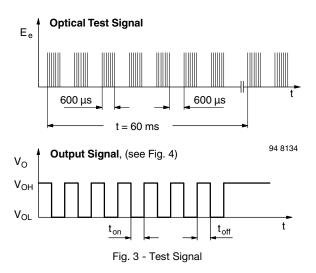


Fig. 2 - Pulse-Width vs. Irradiance in Dark Ambient



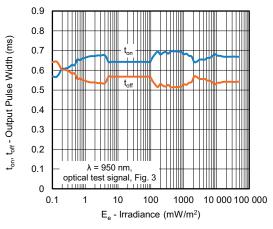


Fig. 4 - Pulse-Width vs. Irradiance in Dark Ambient

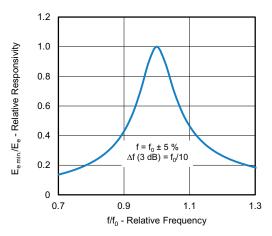


Fig. 5 - Frequency Dependence of Responsivity

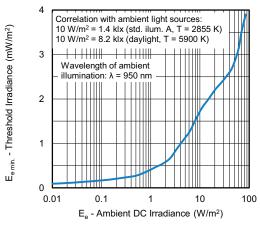


Fig. 6 - Sensitivity in Bright Ambient

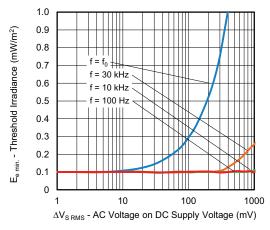


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

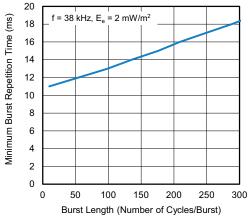


Fig. 8 - Minimum Burst Repetition Time vs. Burst Length

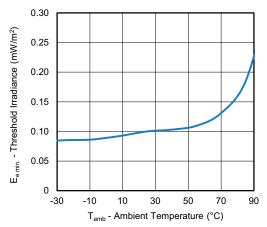


Fig. 9 - Sensitivity vs. Ambient Temperature

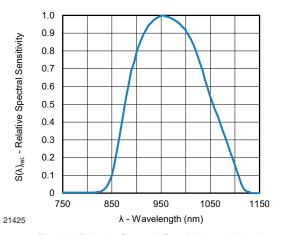


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

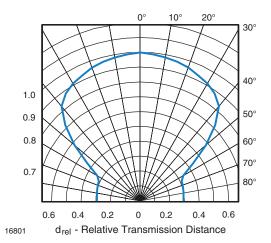


Fig. 11 - Directivity

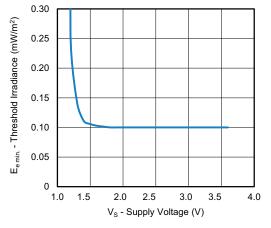


Fig. 12 - Sensitivity vs. Supply Voltage

SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14)

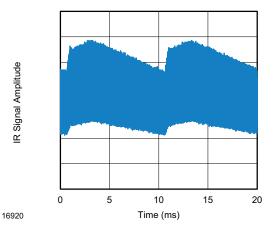


Fig. 13 - IR Emission from Fluorescent Lamp With Low Modulation

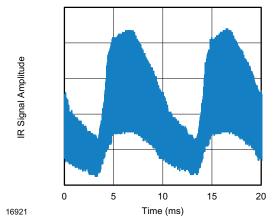


Fig. 14 - IR Emission from Fluorescent Lamp With High Modulation

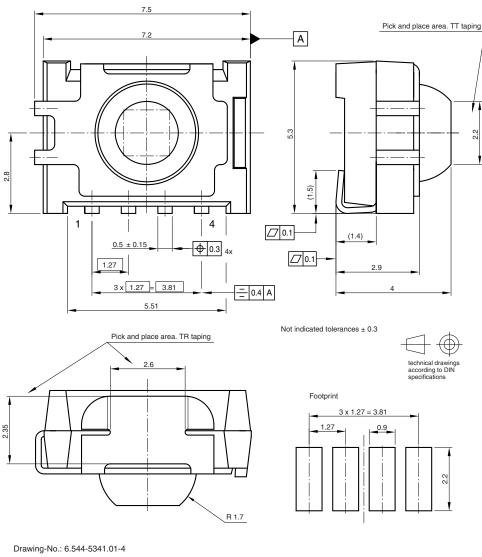
	TSOP966
Minimum burst length	10 cycles/burst
Minimum gap time between bursts	≥ 13 cycles
Minimum idle period between data frames	12 ms
RC-5 code	Preferred
RC-6 code	Yes
NEC code	Preferred
r-step code 56 kHz	Yes
Sony code	No
RCA 56 kHz code	Yes
Mitsubishi code 38 kHz	Preferred
Suppression of interference from fluorescent lamps	Fig. 13 and Fig. 14

Note

• For data formats with short bursts please see the datasheet for TSOP963.., TSOP965..



PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4

ASSEMBLY INSTRUCTIONS

Reflow Soldering

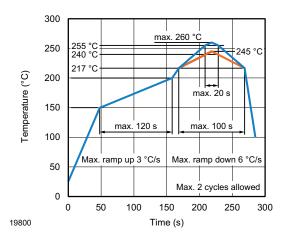
- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

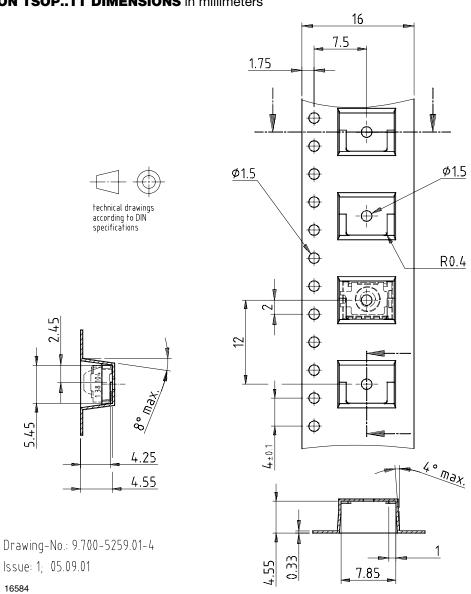
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



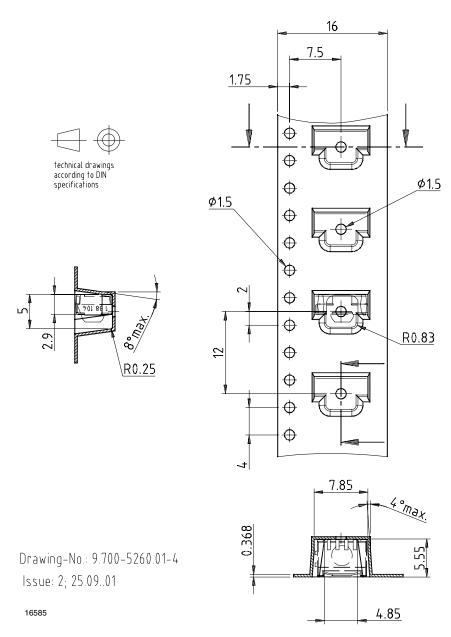
VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TT DIMENSIONS in millimeters

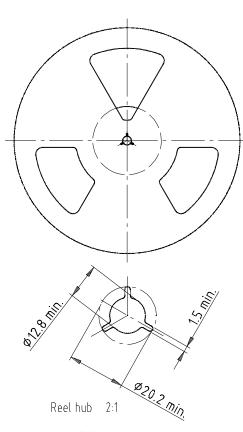


TAPING VERSION TSOP..TR DIMENSIONS in millimeters





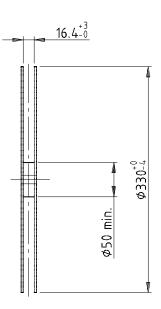
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734



Form of the leave open of the wheel is supplier specific.

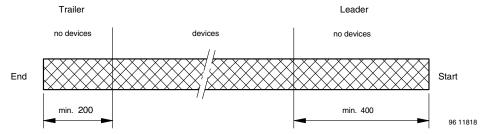
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

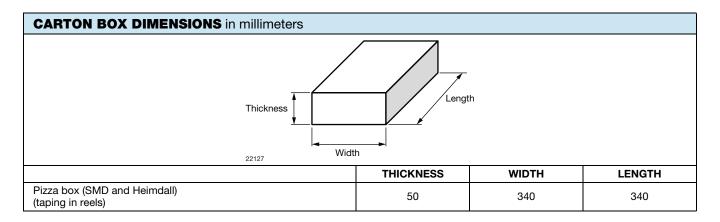
LEADER AND TRAILER DIMENSIONS in millimeters





OUTER PACKAGING

The sealed reel is packed into a pizza box.



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

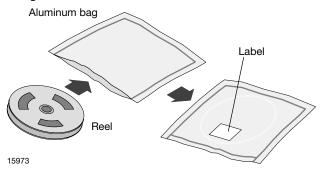
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH	
Item-description	-	18	
Item-number	INO	8	
Selection-code	SEL	3	
LOT-/serial-number	BATCH	10	
Data-code	COD	3 (YWW)	
Plant-code	PTC	2	
Quantity	QTY	8	
Accepted by	ACC	-	
Packed by	PCK	-	
Mixed code indicator	MIXED CODE	-	
Origin	xxxxxxx+	Company logo	
LONG BAR CODE TOP	TYPE	LENGTH	
Item-number	N	8	
Plant-code	N	2	
Sequence-number	X	3	
Quantity	N	8	
Total length	-	21	
SHORT BAR CODE BOTTOM	TYPE	LENGTH	
Selection-code	X	3	
Data-code	N	3	
Batch-number	X	10	
Filter	-	1	
Total length	-	17	



DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

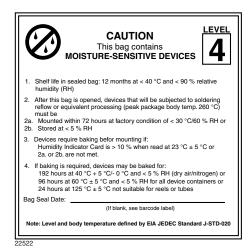
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Vishay

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